MOSFET - Power, Single **N-Channel**

80 V, 32 mΩ, 23 A

NVMFS6H864N

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS6H864NWF Wettable Flank Option for Enhanced Optical Inspection

- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX		
80 V	$32\mathrm{m}\Omega$ @ 10 V	23 A		

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	80	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain		$T_C = 25^{\circ}C$	I _D	21	А
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		15	
Power Dissipation	State	T _C = 25°C	PD	33	W
$R_{\theta JC}$ (Note 1)		$T_{C} = 100^{\circ}C$		16	
Continuous Drain		$T_A = 25^{\circ}C$	Ι _D	6.7	А
Current R _{θJA} (Notes 1, 2, 3)	Steady State	$T_A = 100^{\circ}C$		4.8	
Power Dissipation		$T_A = 25^{\circ}C$	PD	3.5	W
$R_{\theta JA}$ (Notes 1, 2)		$T_A = 100^{\circ}C$		1.7	
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	92	А
Operating Junction and Storage Temperature Range Source Current (Body Diode) Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 1 A)			T _J , T _{stg}	–55 to +175	°C
			ا _S	27.5	А
			E _{AS}	80	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

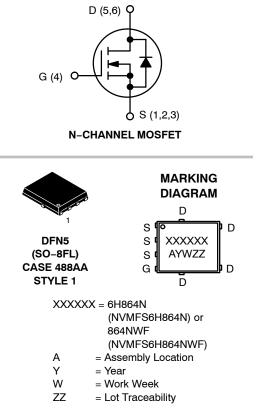
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	4.5	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	43	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

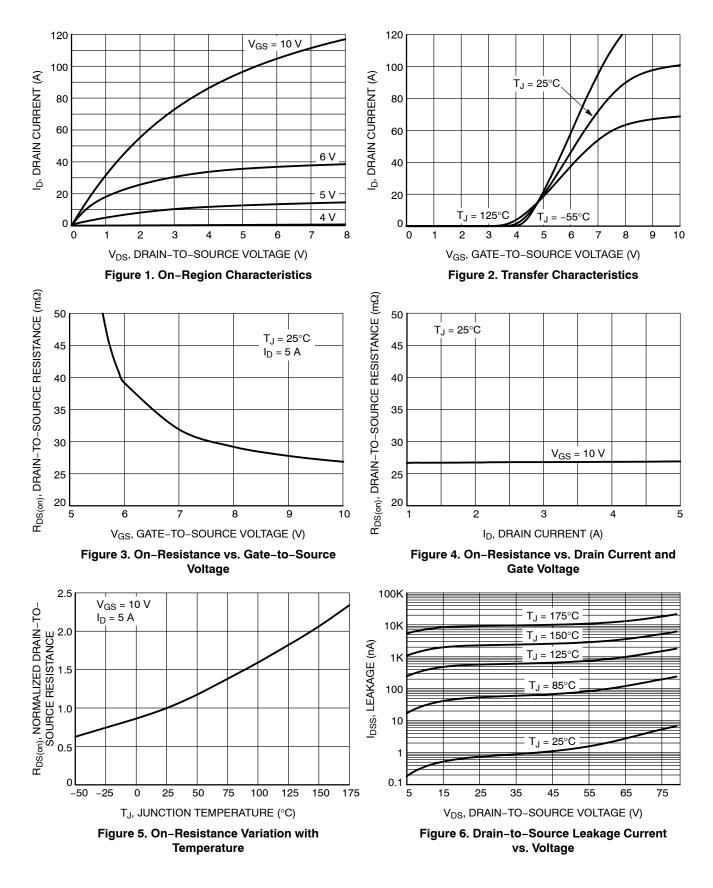
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
$\begin{array}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	OFF CHARACTERISTICS	-						
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		80			V
$ \begin{array}{ c c c c c } \hline V_{DS} = 80 \ V & \hline T_{J} = 125^{\circ} C & I & I & I00 \\ \hline T_{J} = 125^{\circ} C & I & I & I00 & IA \\ \hline \\ $		V _{(BR)DSS} / T _J				54		mV/°C
$ \begin{array}{ c c c c c c } \hline T_{a} = 12^{b^{-1}} & T_{a} = 12^{b^{-1}} & T_{a} = 12^{b^{-1}} & 100 & 10$	Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	T _J = 25 °C			10	μA
			V _{DS} = 80 V	T _J = 125°C			100	
$ \begin{array}{ c c c c c } \hline Gate Threshold Voltage & V_{GS}(TH) & V_{GS} = V_{DS}, \ I_D = 20 \ \mu A & 2.0 & 4.0 & V \\ \hline Threshold Temperature Coefficient & V_{GS}(TH)/T_J & & -7.3 & mV/^C \\ \hline Threshold Temperature Coefficient & V_{GS}(TH)/T_J & & I_D = 5 \ A & 26.9 & 32 & m\Omega \\ \hline Threshold Temperature Coefficient & Q_{GS} & V_{DS} = 10 \ V & I_D = 5 \ A & 26.9 & 32 & m\Omega \\ \hline Threshold Tansconductance & Q_{FS} & V_{DS} = 15 \ V, \ I_D = 10 \ A & 21.8 & S \\ \hline CHARGES, CAPACITANCES & GATE RESISTANCE & & & & & & & & & & & & & & & & & & &$	Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{G}$	_S = 20 V			100	nA
$ \begin{array}{ c c c c c c } \hline \begin{tabular}{ c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	ON CHARACTERISTICS (Note 4)							
$ \begin{array}{ c c c } \hline \mbox{Drain-to-Source On Resistance} & R_{DS(on)} & V_{GS} = 10 \ V & I_D = 5 \ A & 26.9 & 32 & m\Omega \\ \hline \mbox{Forward Transconductance} & g_{FS} & V_{DS} = 15 \ V, \ I_D = 10 \ A & 21.8 & S \\ \hline \mbox{CHARGES, CAPACITANCES & GATE RESISTANCE} \\ \hline \mbox{Input Capacitance} & C_{ISS} & V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 40 \ V & 55 & 0 \\ \hline \mbox{Reverse Transfer Capacitance} & C_{RSS} & V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 40 \ V & 55 & 0 \\ \hline \mbox{Reverse Transfer Capacitance} & C_{GSS} & V_{GS} = 10 \ V, \ V_{DS} = 40 \ V, \ I_D = 10 \ A & 6.9 & 0 \\ \hline \mbox{Total Gate Charge} & Q_{G(TO)} & V_{GS} = 10 \ V, \ V_{DS} = 40 \ V, \ I_D = 10 \ A & 6.9 & 0 \\ \hline \mbox{Threshold Gate Charge} & Q_{G(TH)} & V_{GS} = 10 \ V, \ V_{DS} = 40 \ V, \ I_D = 10 \ A & 6.9 & 0 \\ \hline \mbox{Threshold Gate Charge} & Q_{G(TH)} & V_{GS} = 10 \ V, \ V_{DS} = 40 \ V, \ I_D = 10 \ A & 6.9 & 0 \\ \hline \mbox{Threshold Gate Charge} & Q_{GG} & V_{GS} & 0 \ V, \ V_{DS} = 40 \ V, \ I_D = 10 \ A & 6.9 & 0 \\ \hline \mbox{Threshold Gate Charge} & Q_{GG} & V_{GS} & 0 \ V, \ V_{DS} = 40 \ V, \ I_D = 10 \ A & 6.9 & 0 \\ \hline \mbox{Threshold Gate Charge} & Q_{GG} & V_{GS} & 0 \ V, \ V_{DS} = 40 \ V, \ I_D = 10 \ A & 6.9 & 0 \\ \hline \mbox{Thrmo Data Time} & t_{d(ON)} & V_{GS} & 0 \ V, \ V_{DS} = 64 \ V, \ I_D = 10 \ A, \ R_G = 2.5 \ \Omega & 16 & 0 \\ \hline \mbox{Turn-On Delay Time} & t_{d(OFF)} & 13 & 0 \\ \hline \mbox{Turn-Of Delay Time} & t_{d(OFF)} & 13 & 0 \\ \hline \mbox{Turn-Of Delay Time} & t_{d(OFF)} & 13 & 0 \\ \hline \mbox{Turn-Off Delay Time} & t_{d(OFF)} & 13 & 0 \\ \hline \mbox{Turn-Off Delay Time} & t_{f} & 13 & 0 \\ \hline \mbox{Turn-Off Dolde Voltage} & V_{SD} & V_{SD} & 0 \ V_{GS} = 0 \ V, \ I_S = 5 \ A & 18 & 0 \\ \hline \mbox{Turn-Off Delay Time} & t_{f} & 13 & 0 \\ \hline \mbox{Turn-Off Diole Voltage} & V_{SD} & V_{SD} & 0 \ V_{SD} = 0 \ V, \ I_S = 5 \ A & 13 & 0 \\ \hline \mbox{Turn-Off Diole Voltage} & V_{SD} & 0 \ V_{SD} & 0 \ V_{SD} = 0 \ V, \ I_S = 5 \ A & 0 \ 0 \ V & 0 \ \hline \mbox{Turn-Off Diole Voltage} & V_{SD} & 0 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0$	Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{DS}$	₀ = 20 μA	2.0		4.0	V
$ \begin{array}{ c c c c } \hline Forward Transconductance & G_{FS} & V_{DS} = 15 \ V, \ I_{D} = 10 \ A & 21.8 & S \\ \hline \mbox{CHARGES, CAPACITANCES & GATE RESISTANCE} \\ \hline \mbox{Input Capacitance} & C_{ISS} & & & & & & & & & & & & & & & & & & $	Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-7.3		mV/°C
$ \begin{array}{ c c c c } \hline \text{CHARGES, CAPACITANCES & GATE RESISTANCE} & & & & & & & & & & & & & & & & & & &$	Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 5 A		26.9	32	mΩ
$\begin{array}{ c c c c c c } \hline Input Capacitance & C_{ISS} \\ \hline Output Capacitance & C_{OSS} \\ \hline Output Capacitance & C_{OSS} \\ \hline V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 40 \ V \\ \hline S5 & P \\ \hline S6 &$	Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _I	_D = 10 A		21.8		S
$ \begin{array}{ c c c c c } \hline Output Capacitance & C_{OSS} & V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 40 \ V \\ \hline Meverse Transfer Capacitance & C_{RSS} & & & & & & & & & & & & & & & & & & $	CHARGES, CAPACITANCES & GATE RE	SISTANCE					-	
$\begin{array}{ c c c c c } \hline Reverse Transfer Capacitance & C_{RSS} & & & & & & & & & & & & & & & & & & $	Input Capacitance	C _{ISS}				370		pF
$ \begin{array}{ c c c c } \hline Total \ Gate \ Charge & Q_{G(TOT)} & V_{GS} = 10 \ V, \ V_{DS} = 40 \ V; \ I_D = 10 \ A & 6.9 & \\ \hline \ I_D = 10 \ A, \ V_{DS} = 40 \ V; \ I_D = 10 \ A & \\ \hline \ I_D = 10 \ A, \ V_{DS} = 40 \ V; \ I_D = 10 \ A & \\ \hline \ \ I_D = 10 \ A, \ V_{DS} = 40 \ V; \ I_D = 10 \ A & \\ \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	Output Capacitance	C _{OSS}				55		
$ \begin{array}{ c c c c } \hline Threshold Gate Charge & Q_{G(TH)} \\ \hline Gate-to-Source Charge & Q_{GS} \\ \hline Gate-to-Drain Charge & Q_{GD} \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ $	Reverse Transfer Capacitance	C _{RSS}				3.7		
$ \begin{array}{ c c c c } \hline Gate-to-Source Charge & Q_{GS} \\ \hline Gate-to-Drain Charge & Q_{GD} \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ $	Total Gate Charge	Q _{G(TOT)}				6.9		
$ \begin{array}{ c c c c c } \hline Gate-to-Source Charge & Q_{GS} \\ \hline Gate-to-Drain Charge & Q_{GD} \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ \hline \\ \hline \\ Plateau Voltage & V_{GP} \\ \hline \\ $	Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 40 V; I _D = 10 A			1.5		nC
$ \begin{array}{ c c c c c } \hline Gate-to-Drain Charge & Q_{GD} \\ \hline \\ \hline Plateau Voltage & V_{GP} & & & & & & & & & & & & & & & & & & &$	Gate-to-Source Charge	Q _{GS}				2.4		
$\begin{tabular}{ c c c c c c } \hline SWITCHING CHARACTERISTICS (Note 5) \\ \hline Turn-On Delay Time & t_{d(ON)} \\ \hline Rise Time & t_r & & & & & & & & & & & & & & & & & & &$	Gate-to-Drain Charge	Q _{GD}				1.3		
$\begin{tabular}{ c c c c c c c c c c c } \hline Turn-On Delay Time & t_d(ON) \\ \hline Rise Time & t_r & & & & & & & & & & & & & & & & & & &$	Plateau Voltage	V _{GP}				5.0		V
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	SWITCHING CHARACTERISTICS (Note 5	5)						
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-On Delay Time	t _{d(ON)}				7		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Rise Time	t _r	Vce = 10 V. Vr	$he = 64 V_{c}$		18		1
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-Off Delay Time	t _{d(OFF)}	$I_{\rm D} = 10$ A, $R_{\rm G} = 2.5 \Omega$			16		- ns
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Fall Time	t _f				13		
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	DRAIN-SOURCE DIODE CHARACTERIS	TICS					•	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Forward Diode Voltage	V _{SD}	$V_{CS} = 0 V_{J} \qquad T_{J} = 2$			0.8	1.2	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $		$I_{\rm S} = 5 \rm A$	$I_{\rm S} = 5 \rm A$	$T_J = 125^{\circ}C$		0.7		- V
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs,			28		ns
Discharge Time t _b I _S = 10 A 8	Charge Time	ta				21		
	Discharge Time					8		
	Reverse Recovery Charge					24		nC

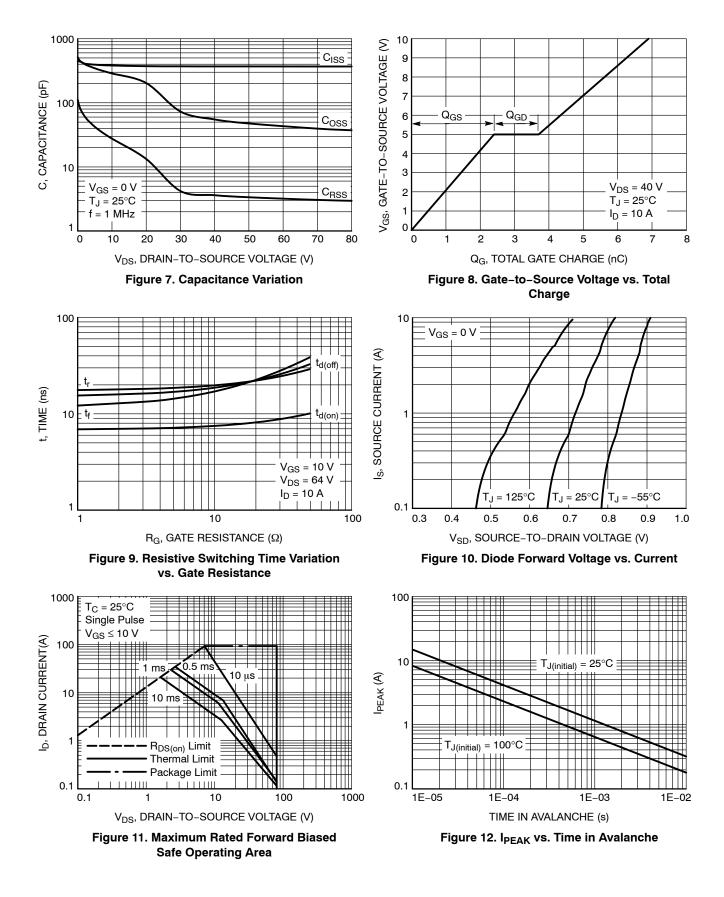
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

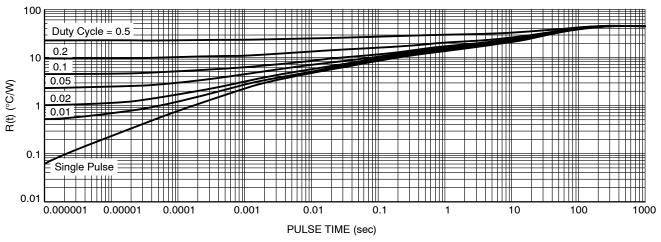


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS6H864NT1G	6H864N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS6H864NWFT1G	864NWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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